MMIC REFLECTIONLESS FILTERS

 50Ω DC to 21 GHz

The Big Deal

- Patented design eliminates in band spurs
- Pass band cut-off up to 21 GHz
- Stop band up to 35 GHz
- Excellent repeatability through IPD* process



Pass and Band Pass designs

Product Overview

Mini-Circuits' X-Series reflectionless filters employs a novel filter topology which absorbs and terminates stop band signals internally rather than reflecting them back to the source. This new capability enables unique applications for filter circuits beyond those suited to traditional approaches. Traditional filters are reflective in the stop band, sending signals back to the source at 100% of the power level which interact with neighboring components and often result in intermodulation and other interferences. Reflectionless filters eliminate stop band reflections, allowing them to be paired with sensitive devices and used in applications that otherwise require circuits such as isolation amplifiers or attenuators.

Key Features	Advantages				
Easy integration with sensitive reflective components, e.g. mixers, multipliers	Reflectionless filters absorb unwanted signals, preventing reflections back to the source. This reduces generation of additional unwanted signals without the need for extra components like attenuators, improving system dynamic range and saving board space.				
Enables stable integration of wideband amplifiers	Because reflectionless filters maintain good impedance in the stop band; they can be integrated with high gain, wideband amplifiers without the risk of creating instabilities in these out of band regions.				
Cascadable	Reflectionless filters can be cascaded in multiple sections to provide sharper and higher attenuation, while also preventing any standing waves that could affect pass band signals.				
Excellent power handling in a tiny surface mount device	High power handling extends the usability of these filters to the transmit path for inter-stage filtering.				
Small size, 3x3mm QFN	Allows replacement of filter/attenuator pairs with a single reflectionless filter, saving board space.				
Excellent repeatability of RF performance	Through semiconductor IPD process, X-series filters are inherently repeatable for large volume production.				
Excellent stability over temperature	With ±0.3 dB variation over temperature ideal for use in wide temperature range applications without the need for additional temperature compensation.				
Operating temperature up to 105°C	Suitable for operation close to high power components.				

^{*}IPD - Integrated Passive Device, is a GaAs semiconductor process

Reflectionless High Pass Filter

XHF-482M+

50Ω 4800 to 19400 MHz

Features

- Match to 50Ω in the stop band, eliminates undesired reflections
- Cascadable
- Excellent Power handling
- Temperature stable, up to 105°C
- Small size, 3 x 3 mm
- Protected by US Patents 8,392,495; 9,705,467, additional patent pending
- Protected by China Patent 201080014266.1
- Protected by Taiwan Patent I581494

Applications

- Wi-Fi
- WiMax
- Microwave Radio
- Military & Space



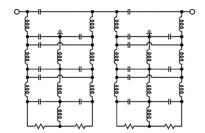
+ROHS Compliant
The +Suffix identifies RoHS Compliance. See our web site for RoHS Compliance methodologies and qualifications

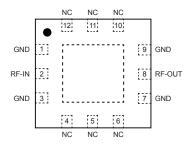


General Description

Mini-Circuits' XHF-482M+ two-section reflectionless filter employs a patented filter topology which absorbs and terminates stop band signals internally rather than reflecting them back to the source. This new capability enables unique applications for filter circuits beyond those suited to traditional approaches. Traditional filters are reflective in the stop band, sending signals back to the source at 100% of the power level. These reflections interact with neighboring components and often result in inter-modulation and other interferences. Reflectionless filters eliminate stop band reflections, allowing them to be paired with sensitive devices and used in applications that otherwise require circuits such as isolation amplifiers or attenuators.

simplified schematic and nad description





Function	Pad Number	Description		
RF-IN	2	RF Input Pad		
RF-OUT	8	RF Output Pad		
GND	1,3,7,9, Paddle	Connected to ground		
NC (GND Externally)	4,5,6,10,11,12	No internal connection		

Electrical Specifications¹ at 25°C

F	Parameter		Frequency (MHz)	Min.	Тур.	Max.	Unit	
Rejection		DC-F1	DC-2400	22	37	_	dB	
		F¹-F1	2400-3600	20	36	_		
Stop Band	Frequency Cut-Off	F2	4390	_	3.0	_	dB	
	VOME		DC-2400	_	1.2	_		
VSWR		F¹-F1	2400-3600	_	1.2	_	:1	
Pass Band	Insertion Loss	F3-F5	4800-19400	_	1.3	2.8	dB	
rass Dallu	VSWR	F3-F5	4800-19400	_	1.2	_	:1	

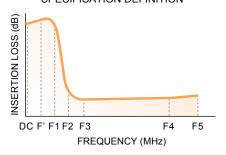
¹ Measured on Mini-Circuits Characterization Test Board TB-844-482MC+

Absolute Maximum Ratings⁴

Parameter	Ratings
Operating Temperature	-55°C to +105°C
Storage Temperature	-65°C to +150°C
RF Power Input, Passband (F3-F5) 2	1.3W at 25°C
RF Power Input, Stopband (DC-F3)3	1.6W at 25°C

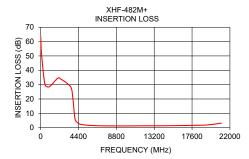
Passband rating derates linearly to 0.6W at 105°C ambient Stopband rating derates linearly to 0.8W at 105°C ambient Permanent damage may occur if any of these limits are exceeded.

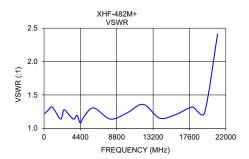
SPECIFICATION DEFINITION



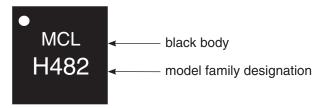
Typical Performance Data at 25°C

Frequency (MHz)	Insertion Loss (dB)	VSWR (:1)
10	63.68	1.22
100	51.65	1.22
500	30.02	1.27
1000	28.47	1.32
2000	34.54	1.14
2400	33.60	1.28
3000	31.19	1.20
3600	26.88	1.14
4000	5.91	1.19
4390	3.03	1.08
4800	2.17	1.17
6000	1.48	1.31
8000	1.26	1.14
10000	1.21	1.23
12000	1.30	1.36
14000	1.33	1.15
16000	1.45	1.21
18000	1.64	1.32
19400	1.90	1.22
21000	3.14	2.41





Product Marking

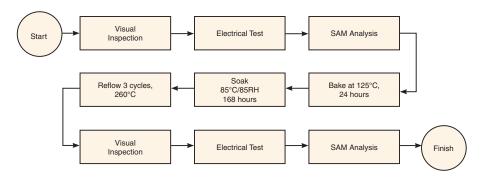


Additional Detailed Technical Information additional information is available on our dash board. To access this information click here Data Table **Performance Data** Swept Graphs S-Parameter (S2P Files) Data Set (.zip file) DQ1225 Plastic package, exposed paddle **Case Style** lead finish: matte-tin F66 Tape & Reel Standard quantities available on reel 7" reels with 20, 50, 100, 200, 500 or 1K devices Suggested Layout for PCB Design PL-451 **Evaluation Board** TB-844-482M+ (without connectors), TB-844-482MC+ (with connectors) **Environmental Ratings** ENV82

ESD Rating

Human Body Model (HBM): Class 2 (Pass 2000V) in accordance with ANSI/ESD STM 5.1 - 2001

MSL Test Flow Chart



Additional Notes

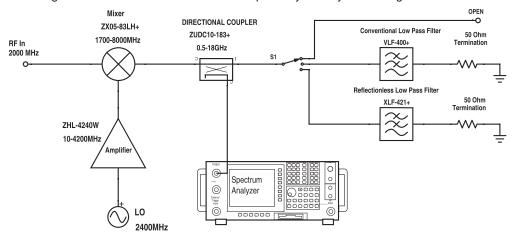
- A. Performance and quality attributes and conditions not expressly stated in this specification document are intended to be excluded and do not form a part of this specification document.
- B. Electrical specifications and performance data contained in this specification document are based on Mini-Circuit's applicable established test performance criteria and measurement instructions.
- C. The parts covered by this specification document are subject to Mini-Circuits standard limited warranty and terms and conditions (collectively, "Standard Terms"); Purchasers of this part are entitled to the rights and benefits contained therein. For a full statement of the Standard Terms and the exclusive rights and remedies thereunder, please visit Mini-Circuits' website at www.minicircuits.com/MCLStore/terms.jsp





Application Circuit Example

Pairing mixers with reflectionless filters to improve system dynamic range



Test block diagram: IF output reflection spectrum with single input frequency

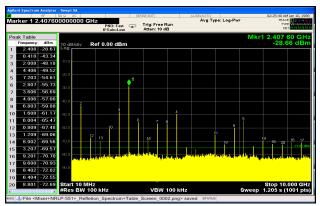


Figure 1. IF output reflection spectrum without filter

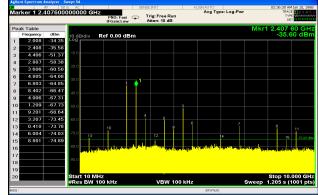


Figure 2. IF output reflection spectrum with conventional filter

An application circuit was assembled to measure the IF reflection spectrum at the output of a mixer when the mixer was paired with a conventional filter versus a reflectionless filter.

While the conventional filter reduces the reflections present when the mixer is used alone (no filter), the reflectionless filter virtually eliminates those reflections altogether.

The reflected signal at marker 1 in the figures above exhibits a reduction of more than 20 dB from -28.7 dBm to -50.3 dBm when the reflectionless filter is used as compared to the conventional filter, thus eliminating unwanted spurious mixing products and improving-system dynamic range.

For more information, refer to application note AN-75-007

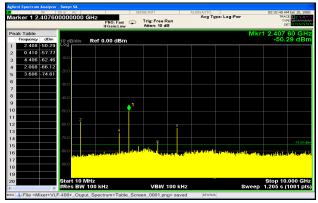


Figure 3. IF output reflection spectrum with reflectionless filter

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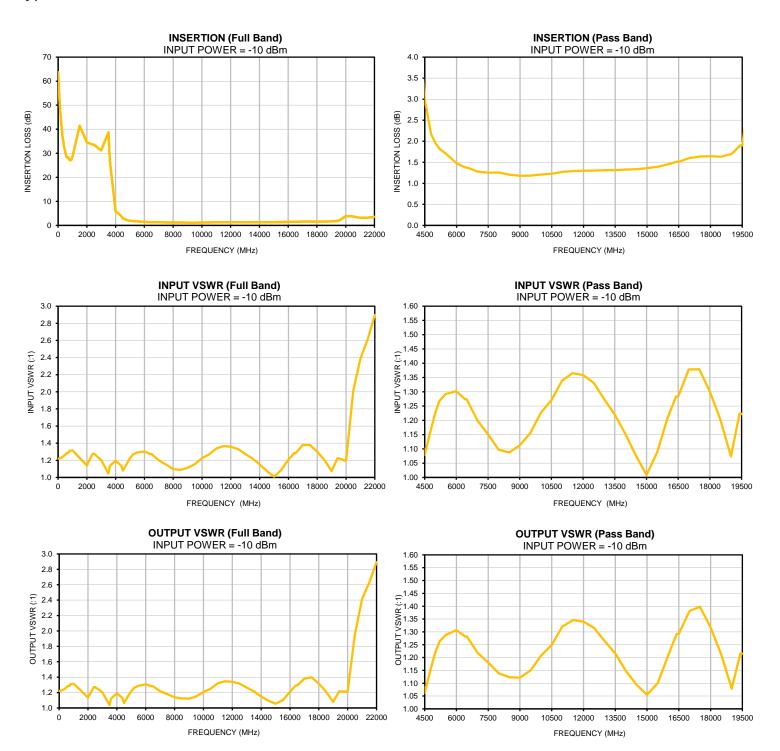
Typical Performance Data

FREQUENCY	INSERTION LOSS	INPUT VSWR	OUTPUT VSWR		
(MHz)	(dB)	(:1)	(:1)		
10	63.68	1.22	1.22		
50	58.04	1.22	1.22		
60	56.20	1.22	1.22		
70	55.21	1.22	1.22		
80	54.01	1.22	1.22		
90	52.90	1.22	1.22		
100	51.65	1.22	1.22		
200	43.82	1.23	1.23		
300	37.44	1.24	1.24		
400	33.27	1.25	1.25		
500	30.44	1.27	1.27		
600	28.34	1.29	1.29		
700 800	28.34 27.14	1.29 1.31	1.29 1.31		
900	27.14	1.31	1.31		
1000	28.47	1.32	1.31		
1500	41.53	1.23	1.23		
2000	34.54	1.14	1.13		
2400	33.60	1.28	1.27		
2500	33.60	1.28	1.27		
3000	31.19	1.20	1.20		
3500	38.75	1.05	1.04		
3600	26.88	1.14	1.12		
4000	5.91	1.19	1.19		
4390	3.93	1.14	1.13		
4500	2.99	1.08	1.06		
4800	2.17	1.17	1.16		
5000	1.96	1.23	1.22		
5200	1.82	1.27	1.26		
5500	1.70	1.29	1.29		
6000	1.48	1.30	1.31		
6420	1.38 1.38	1.27	1.28		
6500 7000	1.28	1.27 1.20	1.28 1.22		
7500	1.26	1.15	1.18		
8000	1.26	1.10	1.14		
8500	1.21	1.09	1.12		
9000	1.18	1.11	1.12		
9500	1.18	1.16	1.15		
10000	1.21	1.23	1.21		
10500	1.23	1.27	1.25		
11000	1.27	1.34	1.32		
11500	1.29	1.37	1.35		
12000	1.30	1.36	1.34		
12500	1.30	1.33	1.32		
13000	1.31	1.27	1.26		
13500	1.31	1.22	1.22		
14000	1.33	1.15	1.15		
14500 15000	1.34 1.36	1.08 1.01	1.09 1.06		
15500	1.39	1.01	1.10		
16000	1.45	1.09	1.10		
16400	1.51	1.28	1.29		
16500	1.51	1.28	1.29		
17000	1.60	1.38	1.38		
17500	1.64	1.38	1.40		
18000	1.64	1.30	1.32		
18500	1.63	1.20	1.21		
19000	1.70	1.07	1.08		
19400	1.90	1.22	1.22		
19500	1.90	1.22	1.22		
20000	3.88	1.19	1.21		
20500	3.76	2.01	1.96		
21000	3.14	2.38	2.41		
21500	3.25	2.61	2.63		
22000	3.55	2.90	2.89		





Typical Performance Curves

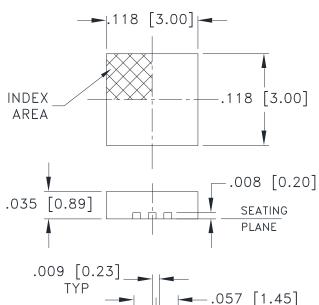


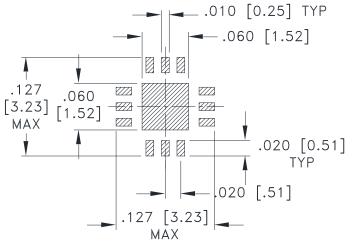


DQ1225

Outline Dimensions

PCB Land Pattern





.009 [0.23] TYP .057 [1.45] .057 [1.45] .016 [0.41] TYP .020 [0.51] TYP

SUGGESTED LAYOUT,
TOLERANCE TO BE WITHIN ±.002

Weight: .02 Grams

Dimensions are in inches (mm). Tolerances: 2Pl. \pm .01; 3 Pl. \pm .004

Notes:

1. Case material: Plastic.

2. Termination finish:

For RoHS Case Styles: Tin-Silver alloy plate over Nickel barrier or Matte-Tin. All models, (+) suffix.

See Data sheet.

For RoHS-5 Case Styles: Tin-Lead plate. All models, no (+) suffix.



INTERNET http://www.minicircuits.com

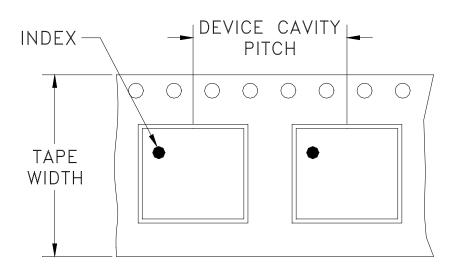
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Mini-Circuits ISO 9001 & ISO 14001 Certified

Tape & Reel Packaging TR-F66

DEVICE ORIENTATION IN T&R



DIRECTION OF FEED

Tape Width,	Device Cavity	Reel Size,	Devic	es per Reel		
mm	Pitch, mm	inches	see note			
				20		
			Small	50		
		7	quantity	100		
8	4		standard	200		
				500		
		7	Standard	1000, 2000, 3000		

Note: Please consult individual model data sheet to determine device per reel availability.

Mini-Circuits carrier tape materials provide protection from ESD (Electro-Static Discharge) during handling and transportation. Tapes are static dissipative and comply with industry standards EIA-481/EIA-541.

Go to: www.minicircuits.com/pages/pdfs/tape.pdf

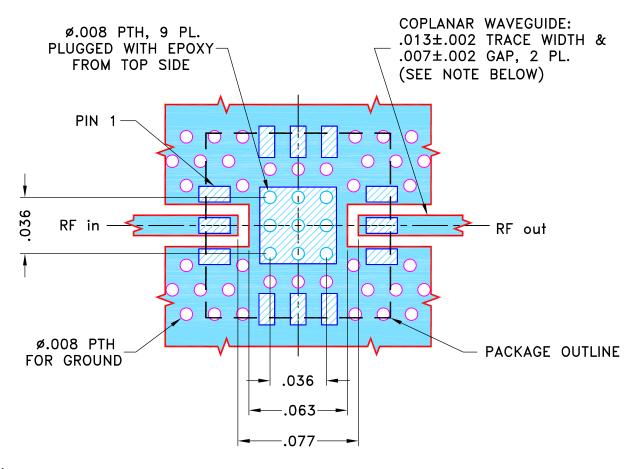


Mini-Circuits ISO 9001 & ISO 14001 Certified

THIRD ANGLE PROJECTION

		REVISIONS			
REV	ECN No.	DESCRIPTION	DATE	DR	AUTH
OR	M152656	NEW RELEASE	09/11/15	ITG	MY

SUGGESTED MOUNTING CONFIGURATION FOR DQ1225 CASE STYLE, "12FL02" PIN CODE



NOTES:

- 1. TRACE WIDTH PARAMETERS ARE SHOWN FOR ROGERS RO4350B WITH DIELECTRIC THICKNESS .0066"±.0007". COPPER: 1/2 OZ. EACH SIDE. FOR OTHER MATERIALS TRACE WIDTH AND GAP MAY NEED TO BE MODIFIED.
- 2. BOTTOM SIDE OF THE PCB IS CONTINUOUS GROUND PLANE.

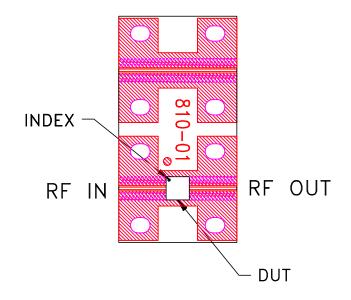
DENOTES PCB COPPER LAYOUT WITH SMOBC (SOLDER MASK OVER BARE COPPER).

DENOTES COPPER LAND PATTERN FREE OF SOLDER MASK.

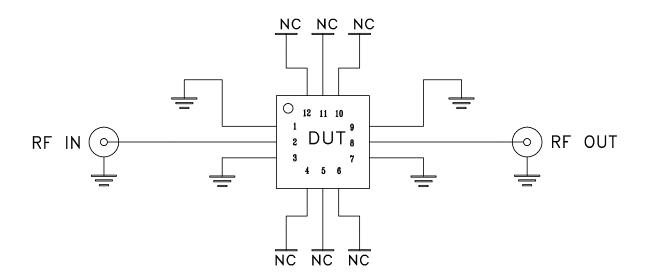
UNLESS OTHERWISE SPECIFIE	D	INITIALS	DATE					R			
DIMENSIONS ARE IN INCHES	DRAWN	ITG	09/10/15		\square Mini	ı — Cı	rcu	1ts :	3 Neptur rooklyn	ne Aver	iue
TOLERANCES ON: 2 PL DECIMALS ±	CHECKED	GF	09/11/15					ופ	rookiyii	NI IIA	,55
3 PL DECIMALS ± .005 ANGLES ±	APPROVED	MY	09/11/15								
FRACTIONS ±				\square PL, 12FL02, DQ1225, TB-844+					-		
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PARTY, IN WHOLE OR IN PART, WITH				FILE:	98PL451	SCALE:	16:1	SHEET:	1	OF	1
	ASHEETA1.D	WG REV:A DA	TE:01/12/95		JOI LIOI		10.1			0 I	

Evaluation Board and Circuit

To be used with Mini-Circuits 50 Ohm 2.92 connectors B20-118-F1+. Connectors are sold separately.



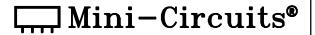
TB-844-482M+



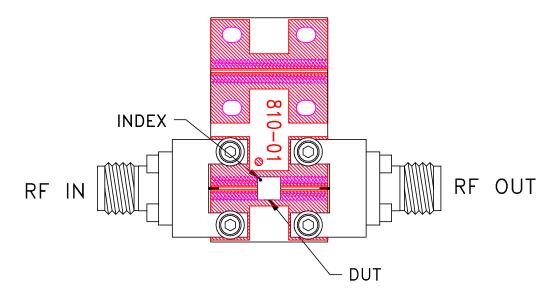
Schematic Diagram

Note:

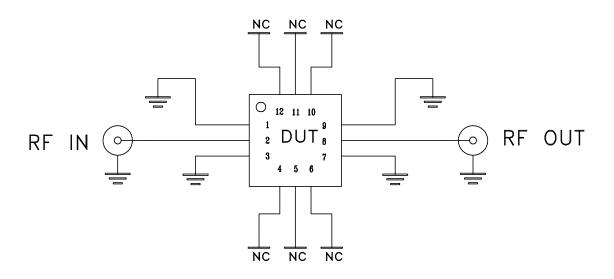
PCB Material: RO4350 or equivalent, Dielectric Constant=3.5, Thickness=.0066 inch.



Evaluation Board and Circuit



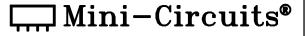
TB-844-482MC+



<u>Schematic Diagram</u>

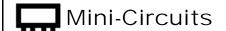
Notes:

- 1. 50 Ohm 2.92 mm Female connectors.
- 2. PCB Material: RO4350 or equivalent, Dielectric Constant=3.5, Thickness=.0066 inch.





ENV82



All Mini-Circuits products are manufactured under exacting quality assurance and control standards, and are capable of meeting published specifications after being subjected to any or all of the following physical and environmental test.

Specification	Test/Inspection Condition	Reference/Spec
Operating Temperature	-55° to 105°C Ambient Environment	Individual Model Data Sheet
Storage Temperature	-65° to 150° C Ambient Environment	Individual Model Data Sheet
Autoclave	15 psig, 100% RH, 121°C, 96 hours	JESD22-A102-C, Condition C
Temperature Cycling	-65° to 150°C, 100 cycles	JESD22-A104
Temperature Humidity	85°C/ 85% RH, 168 hours	JESD22-113
Solder Reflow Heat	Sn-Pb Eutetic Process: 240°C peak Pb-Free Process: 260°C peak	J-STD-020, Table 4-1, 4-2 and 5-2; Figure 5-1
Moisture Sensitivity: Level 1	Bake at 125°C for 24 hours Soak at 85°C/85% RH for 168 hours, Reflow 3 cycles at 240°C peak (Non-RoHS) or 260°C (RoHS)	J-STD-020C
Solderability	10X magnification, 95% coverage	JESD22-B102, Method 1: Dip and Look Test
Marking Resistance to Solvents	Isopropyl alcohol + mineral spirits at 25°C; terpene defluxer at 25°C; distilled water + proylene glycol monomethyl ether + monoethanolamine at 63°C to 70°C	MIL-STD-202, Method 215

ENV82 Rev: OR

10/06/15

M153215 File: ENV82.pdf

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